# **AEC-Q101 Qualified**

# 4V Drive Nch+Nch MOSFET SP8K24FRA

### Structure

Silicon N-channel MOSFET

### Features

- 1) Built-in G-S Protection Diode.
- 2) Small and Surface Mount Package (SOP8).

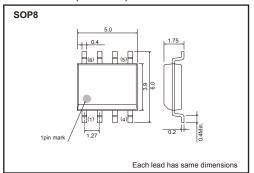
# Applications

Power switching, DC / DC converter, Inverter

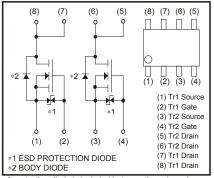
# Packaging dimensions

	Package	Taping
Туре	Code	TB
	Basic ordering unit (pieces)	2500
SP8K24FRA		

### ●Dimensions (Unit:mm)



# ●Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

# ● Absolute maximum ratings (Ta=25°C)

<It is the same ratings for the Tr1 and Tr2.>

Parameter		Symbol	Limits	Unit
Drain-source voltage		$V_{DSS}$	45	V
Gate-source voltage		$V_{GSS}$	±20	V
Drain current	Continuous	I <sub>D</sub>	±6.0	А
	Pulsed	I <sub>DP</sub> *1	±24	А
Source current	Continuous	Is	1	А
(Body diode)	Pulsed	I <sub>SP</sub> *1	24	Α
Total power dissipation		P <sub>D *2</sub>	2	W / TOTAL
		□ *2	1.4	W / ELEMENT
Chanel temperature		T <sub>ch</sub>	150	°C
Range of Storage temperature		T <sub>stg</sub>	-55 to +150	°C

<sup>\*1</sup> PW ≤10μs, Duty cycle ≤ 1%

<sup>\*2</sup> Mounted on a ceramic board

# ●Electrical characteristics (Ta=25°C)

<It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Gate-source leakage	I <sub>GSS</sub>	-	_	±10	μА	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	
Drain-source breakdown voltage	V(BR) DSS	45	_	_	V	I <sub>D</sub> = 1mA, V <sub>G</sub> S=0V	
Zero gate voltage drain current	I <sub>DSS</sub>	-	_	1	μА	V <sub>DS</sub> = 45V, V <sub>GS</sub> =0V	
Gate threshold voltage	V <sub>GS (th)</sub>	1.0	_	2.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	
Otatio ducin accusa an atata		_	18	25	mΩ	I <sub>D</sub> = 6.0A, V <sub>GS</sub> = 10V	
Static drain-source on-state resistance	RDS (on)*	_	24	34	mΩ	ID= 6.0A, VGS= 4.5V	
resistance		_	26	37	mΩ	I <sub>D</sub> = 6.0A, V <sub>GS</sub> = 4.0V	
Forward transfer admittance	Y <sub>fs</sub>   *	6.0	_	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6.0A	
Input capacitance	Ciss	_	1400	_	pF	V <sub>DS</sub> = 10V	
Output capacitance	Coss	_	310	_	pF	V <sub>GS</sub> =0V	
Reverse transfer capacitance	Crss	_	175	_	pF	f=1MHz	
Turn-on delay time	t <sub>d (on)</sub> *	_	19	_	ns	V <sub>DD</sub> ≒ 25V	
Rise time	tr *	_	30	_	ns	I <sub>D</sub> = 3.0A V <sub>GS</sub> = 10V	
Turn-off delay time	td (off) *	_	72	_	ns	$R_{i} = 8\Omega$	
Fall time	t <sub>f</sub> *	_	27	_	ns	R <sub>G</sub> =10Ω	
Total gate charge	Qg *	_	15.4	21.6	nC	V <sub>DD</sub> ≒25V, V <sub>GS</sub> =5V	
Gate-source charge	Qgs *	_	3.7	_	nC	I <sub>D</sub> = 6.0A	
Gate-drain charge	Qgd *	_	6.5	_	nC	$R_L=4\Omega$ , $R_G=10\Omega$	

<sup>\*</sup>Pulsed

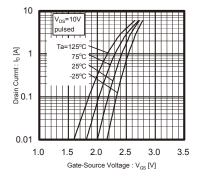
# $\bullet \textbf{Body diode characteristics} \ ( Source-drain ) \ ( Ta=25^{\circ}C )$

<It is the same characteristics for the Tr1 and Tr2.>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	V <sub>SD</sub> *	_	_	1.2	V	I <sub>S</sub> =6.0A/V <sub>GS</sub> =0V

<sup>\*</sup> pulsed

### Electrical characteristic curves



1000 | Ta=125°C | Ta=1

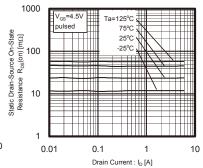
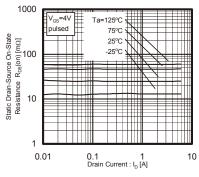
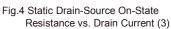


Fig.1 Typical Transfer Characteristics

Fig.2 Static Drain-Source On-State Resistance vs. Drain Current (1)

Fig.3 Static Drain-Source On-State Resistance vs. Drain Current (2)





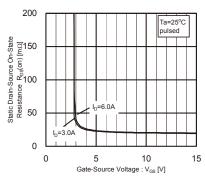


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

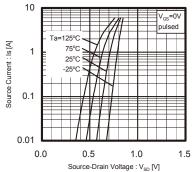


Fig.6 Source-Current vs. Source-Drain Voltage

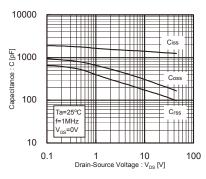


Fig.7 Typical capacitance vs. Source-Drain Voltage

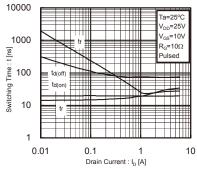


Fig.8 Switching Characteristics

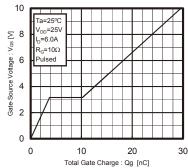


Fig.9 Dynamic Input Characteristics

# Measurement circuits

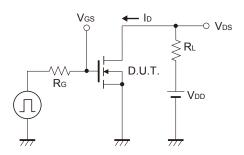


Fig.10 Switching Time Test Circuit

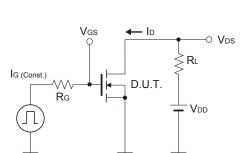


Fig.12 Gate Charge Test Circuit

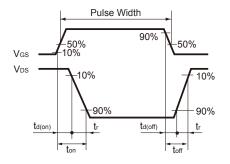


Fig.11 Switching Time Waveforms

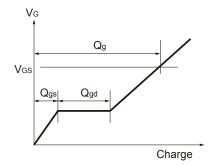


Fig.13 Gate Charge Waveform

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(Note1) Medical Equipment Classification of the Specific Applications

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JAPAN	USA	EU	CHINA				
CLASSⅢ	CLASSⅢ	CLASSIIb	CLASSIII				
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII				

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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